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DRAFT AMENDMENT FOR COMMENTS ONLY**

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Draft Amendment no 1, December 2023 to

IS/IEC 60127 (Part 4):2005 Miniature fuses – Part 4: Universal modular fuse-links (UMF) – Through-hole and surface mount types

Fuses Sectional Committee, ETD 39

Last date for Comments – 22 Jan 2024

This draft amendment is identical to amendment 1 (2008-05) and amendment 2 (2012-12) to IEC 60127-4:2005 issued by International Electrotechnical Commission (IEC)

Note: The technical content of the document is not available on website. For details, please refer the corresponding IEC 60127-4:2005/Amd 1:2008 & Amd 2:2012 or kindly contact:

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